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Kwak

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(54) **FLAT PANEL DISPLAY**

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H01J 63/04 (2006.01)

(52) **U.S. Cl.** **313/506**

(58) **Field of Classification Search** 313/506,
313/512

See application file for complete search history.

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(57) **ABSTRACT**

A display includes: a display area adapted to form an image
with display devices arranged on a substrate; a sealing portion
adapted to seal at least the display area with a sealant arranged
along an outer edge portion of the display area; and a driving
power supply line adapted to supply a driving voltage to the
display area. The driving power supply line includes at least
one conductive layer, at least a portion thereof being arranged
between the sealing portion and the substrate. Each conduc-
tive layer includes at least one penetration hole.

28 Claims, 10 Drawing Sheets

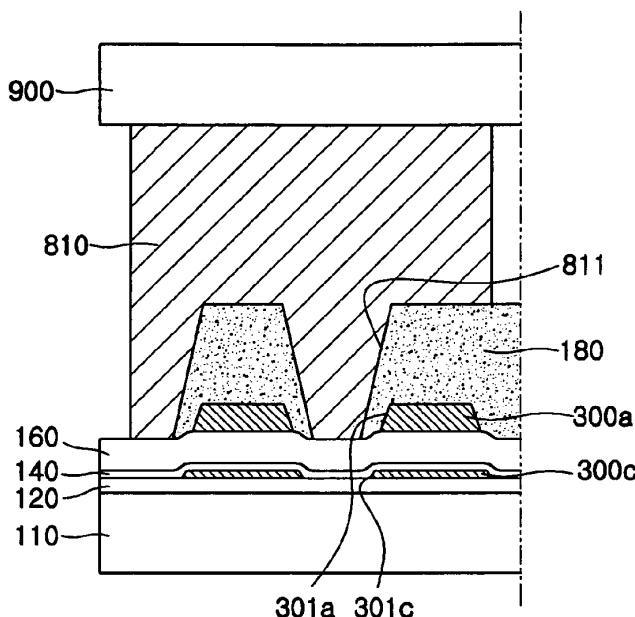


FIG. 2A

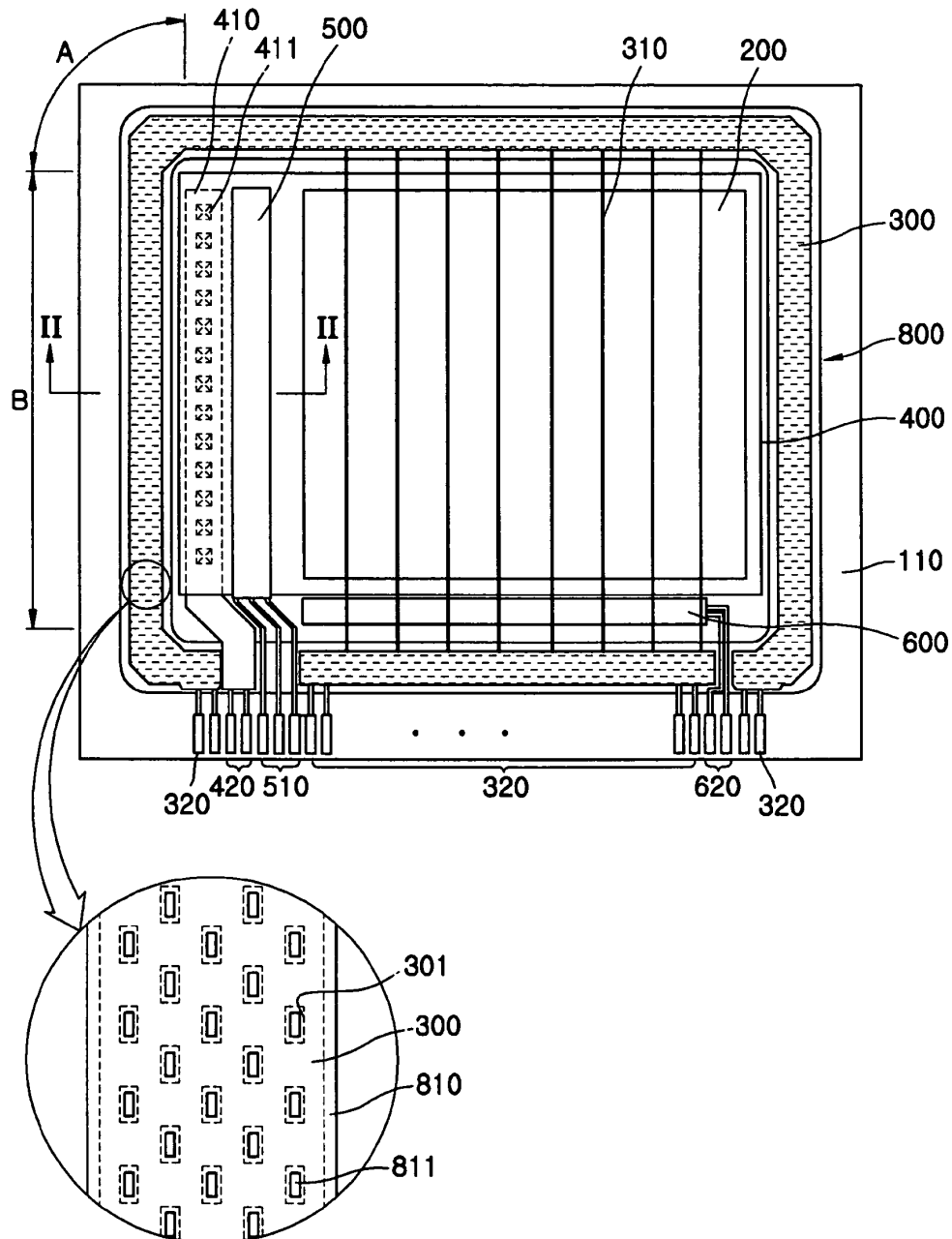


FIG. 2B

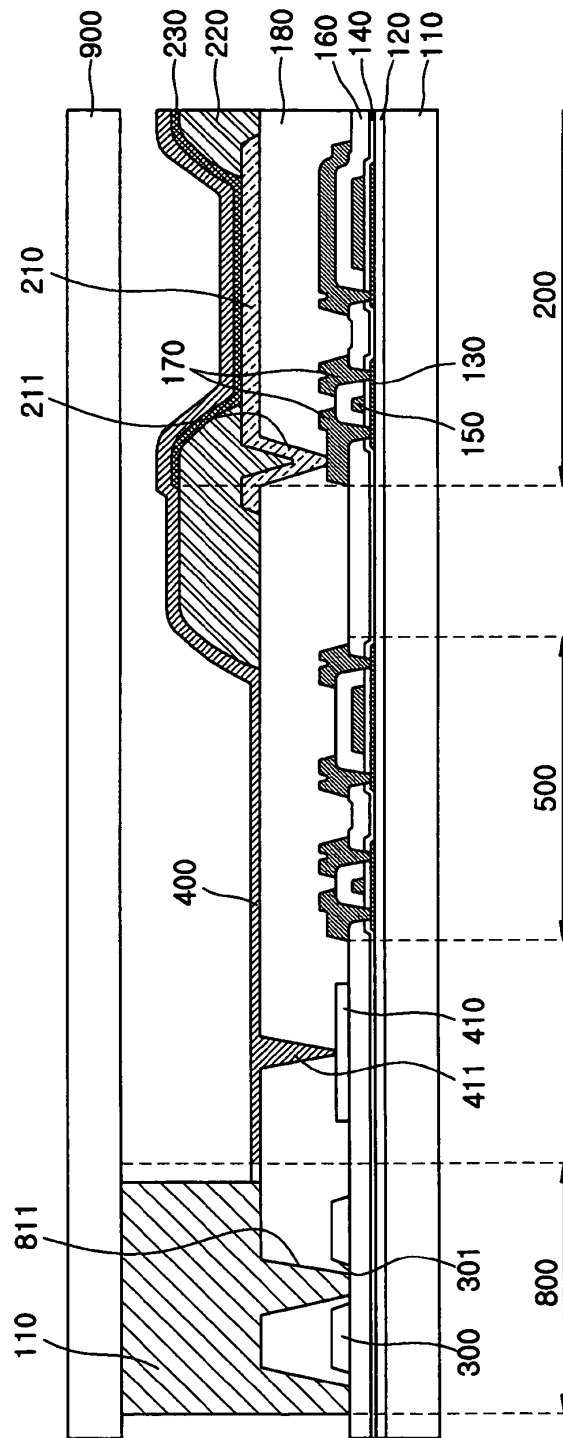


FIG. 2C

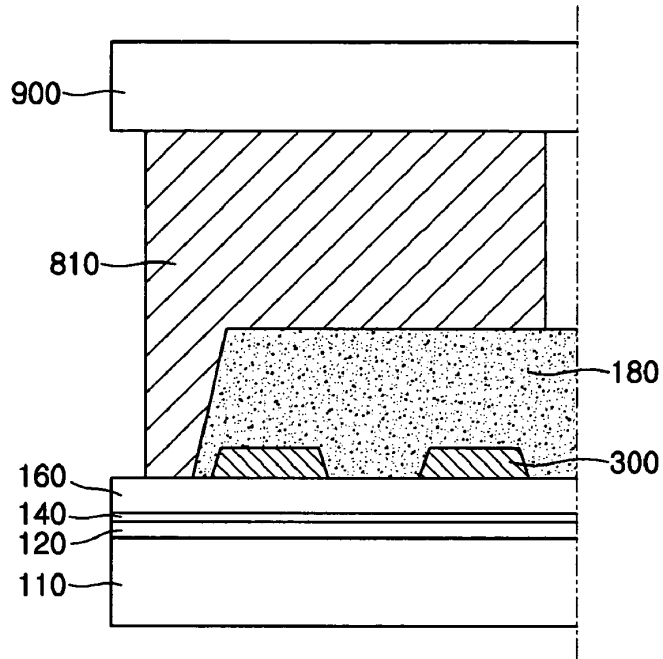


FIG. 2D

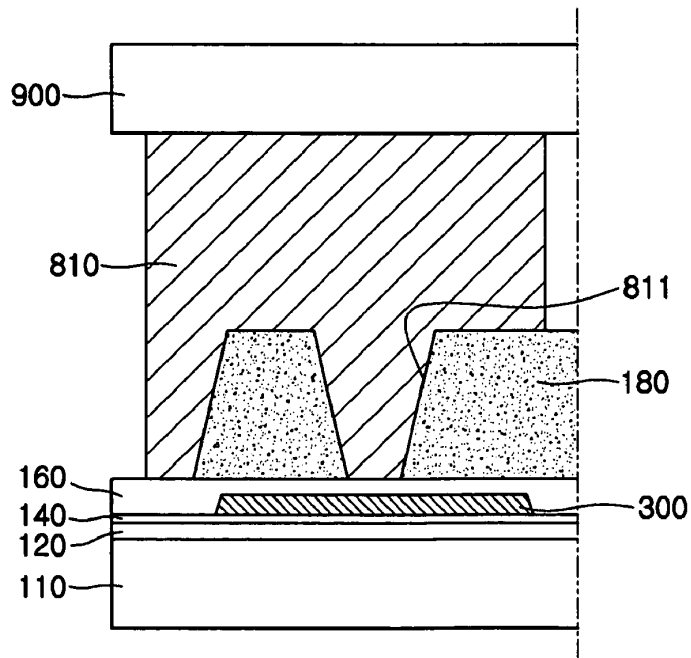


FIG. 3A

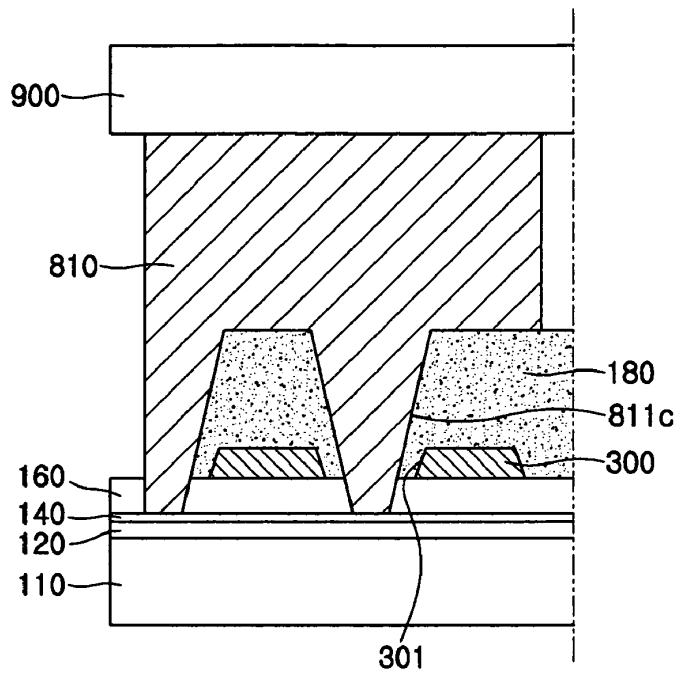


FIG. 3B

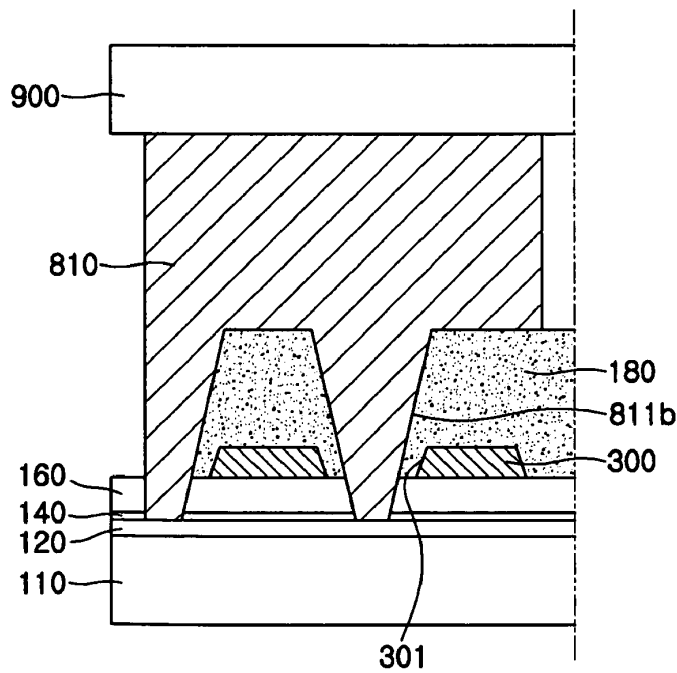


FIG. 3C

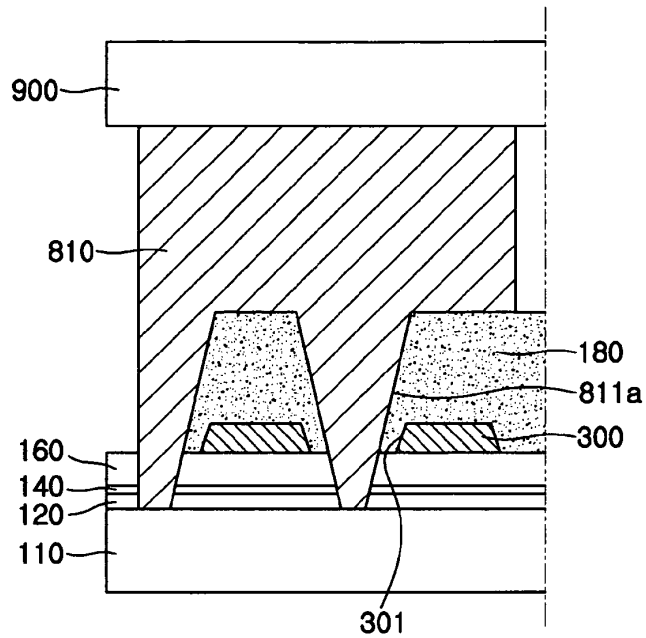


FIG. 4A

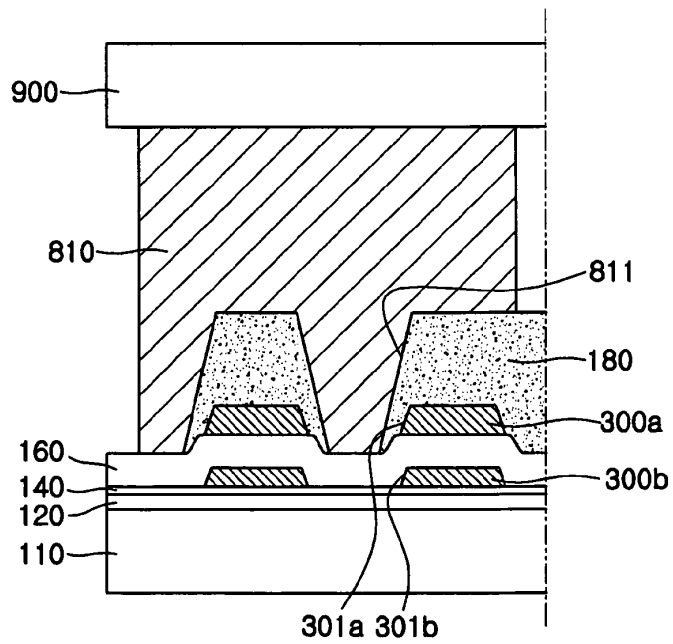


FIG. 4B

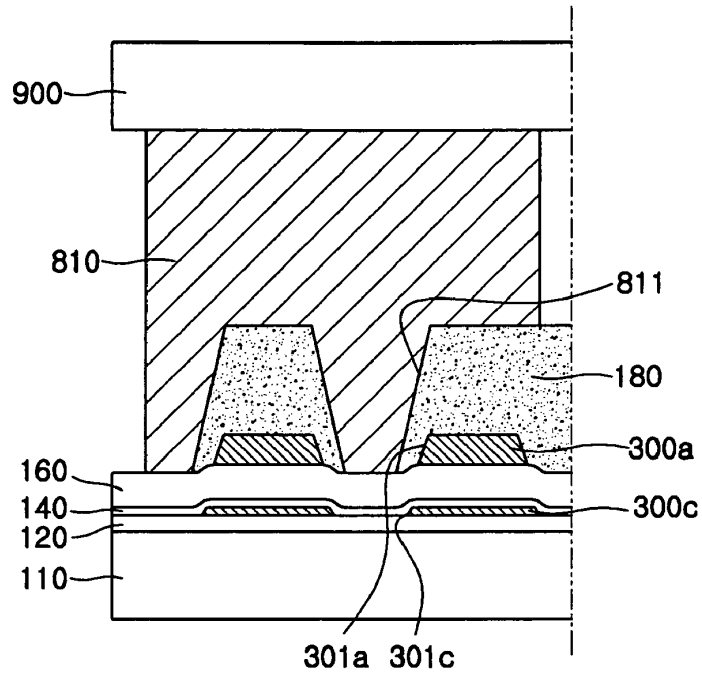


FIG. 4C

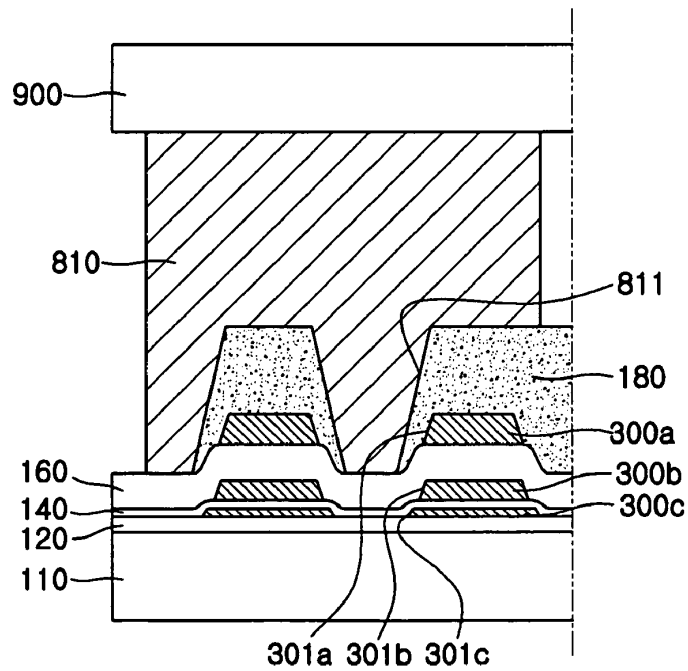


FIG. 5B

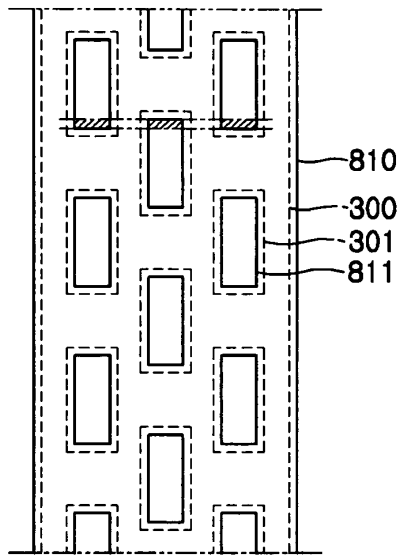


FIG. 5C

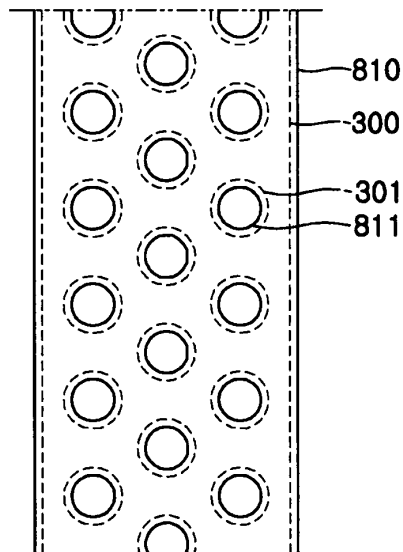


FIG. 5D

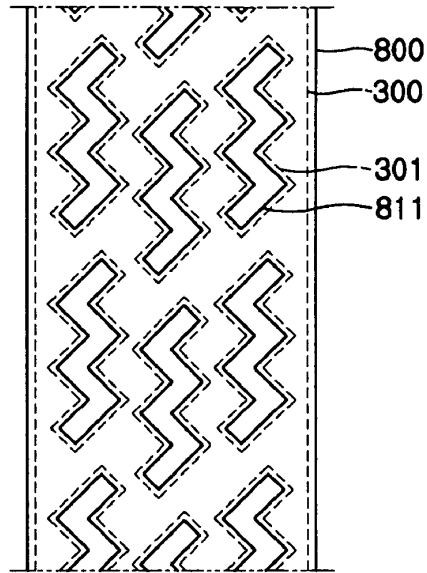
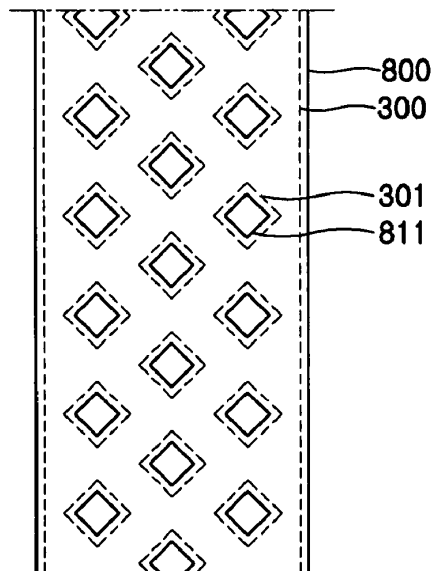


FIG. 5E



1

FLAT PANEL DISPLAY

CLAIM OF PRIORITY

This application makes reference to, incorporates the same herein, and claims all benefits accruing under 35 U.S.C. §119 from an application for FLAT PANEL DISPLAY DEVICE earlier filed in the Korean Intellectual Property Office on Feb. 14, 2004 and Feb. 18, 2004 and there duly assigned Ser. No(s). 2004-9843 and 2004-10670, respectively.

BACKGROUND OF THE INVENTION

1. Field of the Invention

The present invention relates to a display, and more particularly, to a flat panel display having a wide display area at least partially impervious to degradation caused by moisture.

2. Description of the Related Art

Flat panel displays, such as liquid crystal displays, organic electroluminescent displays, and inorganic electroluminescent displays can be classified as either Passive Matrix (PM) displays and Active Matrix (AM) displays according to the driving method thereof. In the PM display, positive electrodes and negative electrodes are arranged in columns and rows, and scanning signals are supplied to the negative electrodes from a row driving circuit. One row is selected. In addition, data signals are converted into pixels by a column driving circuit. In the AM display, signals converted into pixels are controlled by a Thin Film Transistor (TFT). The AM display is suitable for processing an enormous amount of data and for displaying moving pictures.

An organic Electroluminescent (EL) display has an organic light emitting layer of an organic material arranged between an anode and a cathode. In the organic EL display, when a voltage is applied across the electrodes, holes move from the anode through a hole transport layer into an organic light emitting layer, and electrons move through an electron transport layer into the organic light emitting layer. The electrons and holes recombine in the organic light emitting layer to form excitons, and when the excitons deexcite, fluorescent molecules in the organic light emitting layer emit light to form an image. In a full-color organic EL display, pixels for generating Red (R), Green (G), and Blue (B) colors are used to realize full-color.

However, in the organic EL display, organic layers including the organic light emitting layer are very vulnerable to moisture. Thus, in order to protect the organic light emitting layer from moisture and to protect a display area of the display from external shock, the layers are sealed using a substrate or a metal cap.

FIG. 1A is a plan view of an AM organic EL display, and FIG. 1B is a cross-sectional view taken along line I-I of FIG. 1.

The AM organic EL display includes a predetermined area 20 that includes an organic EL device on a transparent base substrate 11, and a metal cap 90 that is sealed by a sealing portion 80 comprising a sealant 81 arranged on the display area 20 so as to seal the display area 20. The display area 20 includes a plurality of pixels, each of which includes the organic EL device having a TFT. In addition, a cathode 40 is arranged on an upper portion of the display area 20, and the cathode 40 is connected to an external terminal area 70 through an electrode routing unit 41 that is arranged on one side of the display area 20. Also, a plurality of driving lines (VDDs) 31 are arranged on the display area 20 and connected to the external terminal area 70 through a driving voltage routing unit 30 arranged on an outer portion of the display

2

area 20. The VDDs supply driving voltage to the display area 20. A vertical circuit unit 50 and a horizontal circuit unit 60, which input signals to the TFT of the display area 20, are further arranged on an outer portion of the display area and are connected to the terminal area 70 through circuit routing units 51 and 61.

In the AM organic EL display described above, the metal cap 90 seals a portion including the display area 20, the routing units 51 and 61, and the circuit units 50 and 60, and excluding only the terminal area 70. Therefore, the sealing portion 80 includes the routing units 51 and 61 and the circuit units 50 and 60 which do not display images, as well as the display area 20 on which images are displayed. Thus, a proportion of the display area 20 that emits light is reduced with respect to the entire size of the display, and accordingly, a dead space, that is, a non-emitting area increases, thereby lowering efficiency.

Moreover, in the organic EL display of FIGS. 1A and 1B, since widths of the routing units 51 and 61 that connect the display area 20 and the terminal area 70 must be thin, the resistance of the routing units is inevitably increased.

The above problem generally occurs in conventional AM type organic EL displays, including the organic EL display of Japanese Laid-Open Patent No. 2000-173779.

On the other hand, U.S. Pat. No. 6,359,606 refers to a technology that forms a protection layer for sealing an entire surface of the display, instead of using a sealing member such as the metal cap or a glass substrate. Thus, the protection layer, instead of the sealing member, protects and preserves the organic EL device by keeping out moisture and oxygen.

However, in the AM display described above, the protection layer is just a thin film, so internal devices are not protected sufficiently. In addition, there is a limit to the protection provided by the protection layer to the organic EL device, which should be protected completely from moisture.

U.S. Pat. No. 5,882,761 refers to a display that further includes a drying substance in the metal cap or glass substrate in order to further protect the organic EL device from moisture. Moreover, the display having the thin protection layer cannot be a front-emission display or a dual-emission display, which form images in a direction of the sealing member.

Korean Laid-open Patent Publication No. 2002-9498 refers to a display in which an EL device is sealed using a covering member and a sealing member including a plurality of wires connected to each other in parallel between the sealing member and the substrate. However, in order to manufacture the display, a plurality of wires having narrow widths must be formed and connected in parallel. Thus, the apparatus has a complex structure and a high line resistance.

SUMMARY OF THE INVENTION

The present invention provides a display, and more particularly, an organic electroluminescent flat panel display, in which a panel (substrate) size is reduced and a sealing function is simultaneously improved.

According to an aspect of the present invention, a display is provided comprising: a display area adapted to form an image with display devices arranged on a substrate; a sealing portion adapted to seal at least the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer having at least a portion thereof arranged between the sealing portion and the substrate, and wherein each conductive layer includes at least one penetration hole.

3

The at least one conductive layer including the penetration hole preferably comprises a layer of the same material as that of source/drain electrodes arranged on the display area.

The at least one conductive layer including the penetration hole preferably comprises a layer of the same material as that of a gate electrode arranged on the display area.

The display devices preferably comprise organic electroluminescent display devices.

According to another aspect of the present invention, a display is provided comprising: a display area adapted to display an image with display devices arranged on a substrate; a sealing portion adapted to seal the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer having at least a portion thereof arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line contacting the sealant, and wherein the at least one via hole extends so that a portion of the sealant closely contacts an inorganic layer under the protection layer.

The protection layer preferably comprises at least one organic layer.

At least one penetration hole is preferably arranged in the conductive layer between the cross-section and the protection layer.

A position of the at least one penetration hole and a position of the at least one via hole preferably correspond to each other.

A cross-section of the at least one via hole is smaller than that of a corresponding at least one penetration hole.

The conductive layer arranged between the cross-section and the protection layer preferably comprises a layer of the same material as that of source/drain electrodes on the display area.

The conductive layer arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer preferably comprises a layer of the same material as that of a gate electrode on the display area.

The inorganic layer at the bottom of the at least one via hole is preferably of the same material as that of an interlayer on the display area.

The inorganic layer at the bottom of the at least one via hole is preferably of the same material as that of a gate insulating layer on the display area.

The inorganic layer at the bottom of the at least one via hole is preferably of the same material as that of a buffer layer on the display area.

The bottom surface of the at least one via hole preferably contacts a surface of the substrate.

The display devices preferably comprise organic electroluminescent devices.

According to another aspect of the present invention, an organic electroluminescent display is provided comprising: a display area adapted to display an image with organic electroluminescent devices arranged on a substrate; a sealing portion adapted to seal at least the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, at least a portion thereof being arranged between the sealing portion and the substrate and at least one penetration hole is formed in a portion of the at least one conductive layer.

According to yet another aspect of the present invention, an organic electroluminescent display is provided comprising: a

4

display area adapted to display an image with organic electroluminescent devices arranged on a substrate; a sealing portion adapted to seal at least the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, at least a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line, and wherein the at least one via hole is extended so that a portion of the sealant directly contacts an inorganic layer under the protection layer.

According to still another aspect of the present invention, an organic electroluminescent display is provided comprising: a display area adapted to display an image with organic electroluminescent devices arranged on a substrate; a sealing portion adapted to seal at least the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line, and wherein the at least one via hole is extended so that a portion of the sealant directly contacts an inorganic layer under the protection layer, and wherein at least one penetration hole is arranged in the conductive layer arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer.

According to yet another aspect of the present invention, a display is provided comprising: a display area adapted to display an image with organic electroluminescent devices arranged on a substrate; a sealing portion adapted to seal the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, at least a portion thereof being arranged between the sealing portion and the substrate and at least one penetration hole arranged on at least a portion of the at least one conductive layer, and wherein at least one penetration hole is arranged in a corner of the driving power supply line and extends continuously around the corner.

The at least one conductive layer is preferably arranged in the corner of the driving power supply line and includes at least one layer of the same material as that of source/drain electrodes on the display area.

The at least one conductive layer is preferably arranged in the corner where the at least one penetration hole is arranged and includes at least one layer of the same material as that of a gate electrode on the display area.

According to still another aspect of the present invention, a display is provided comprising: a display area adapted to display an image with display devices arranged on a substrate; a sealing portion adapted to seal the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on top of the driving power supply line and extending so that a portion of the sealant directly contacts an inorganic layer under the protection layer through the at least one via hole, and wherein at least one via hole is arranged in

5

the protection layer where it overlaps a corner of the sealing portion extending around a corner.

The protection layer preferably comprises at least one organic layer.

At least one penetration hole is preferably arranged around the corner portion of the at least one conductive layer between the inorganic layer at the bottom of the at least one via hole and the protection layer.

A position of the at least one penetration hole in the corner portion of the at least one conductive layer preferably corresponds to a position of the at least one via hole.

A cross-section of the at least one via hole is preferably smaller than that of a corresponding at least one penetration hole.

The at least one conductive layer is preferably arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer and includes a layer of the same material as that of source/drain electrodes on the display area.

The at least one conductive layer is preferably arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer and includes a layer of the same material as that of a gate electrode on the display area.

The inorganic layer at the bottom of the at least one via hole in the corner portion is preferably of the same material as that of an interlayer on the display area.

The inorganic layer at the bottom of the at least one via hole in the corner portion is preferably of the same material as that of a gate insulating layer on the display area.

The inorganic layer at the bottom of the at least one via hole in the corner portion is preferably of the same material as that of a buffer layer on the display area.

The bottom of the at least one via hole in the corner preferably contacts a surface of the substrate.

The display devices preferably comprise organic electroluminescent devices.

According to yet still another aspect of the present invention, a display is provided comprising: a display area adapted to display an image with display devices arranged on a substrate; a sealing portion adapted to seal the display area with a sealant arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, a portion thereof being arranged between the sealing portion and the substrate and at least one penetration hole arranged in at least a portion of the at least one conductive layer, and wherein at least one penetration hole is arranged where the at least one conductive layer overlaps the sealing portion transversely with a portion of a neighboring penetration hole arranged toward the display area.

According to another aspect of the present invention, a display is provided comprising: a display area adapted to display an image with display devices arranged on a substrate; a sealing portion adapted to seal the display area with a sealing material arranged along an outer edge portion of the display area; and a driving power supply line adapted to supply a driving voltage to the display area; wherein the driving power supply line includes at least one conductive layer, a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on a top of the driving power supply line and extending so that at least a portion of the sealing material directly contacts an inorganic layer under the protection layer through the at least one via hole, and wherein at least one via hole is arranged in the protection layer where

6

it overlaps the sealing portion transversely with a portion of a neighboring via hole arranged toward the display area.

At least one penetration hole is preferably arranged at a position corresponding to the at least one via hole in a conductive layer arranged between the inorganic layer at the bottom of the at least one via hole, and the protection layer.

BRIEF DESCRIPTION OF THE DRAWINGS

A more complete appreciation of the present invention, and many of the attendant advantages thereof, will be readily apparent as the present invention becomes better understood by reference to the following detailed description when considered in conjunction with the accompanying drawings in which like reference symbols indicate the same or similar components, wherein:

FIG. 1A is a schematic plan view of a conventional flat panel display;

FIG. 1B is a schematic cross-sectional view taken along line I-I of FIG. 1A;

FIG. 2A is a schematic plan view of a flat panel display according to an embodiment of the present invention;

FIG. 2B is a schematic cross-sectional view taken along line II-II of FIG. 2A;

FIG. 2C is a schematic cross-sectional view of the flat panel display of FIG. 2A including a penetration hole;

FIG. 2D is a schematic cross-sectional view of the flat panel display of FIG. 2A including a sealant arranged on a via hole of a protection layer according to an embodiment of the present invention;

FIGS. 3A through 3C are schematic cross-sectional views of a sealing portion in a flat panel display according to another embodiment of the present invention;

FIGS. 4A through 4C are schematic cross-sectional views of a sealing portion in a flat panel display according to still another embodiment of the present invention;

FIG. 5A is a schematic plan view of a corner of a sealing portion according to an embodiment of the present invention; and

FIGS. 5B through 5E are schematic plan views of an edge of the sealing portion shown in FIG. 5A according to an embodiment of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

FIG. 2A is a view of a flat panel display, and more specifically, an organic electroluminescent (EL) display, according to an embodiment of the present invention. However, the present invention is not limited to the organic EL display of FIG. 2A.

The organic EL display of FIG. 2A includes a display area **200**, on which a light emitting device, such as an organic EL device, is arranged on a substrate **110**, a sealing portion **800** applied to an outer edge of the display area **200** to seal the substrate **110** and a sealing substrate (**900** in FIG. 2B), and a terminal area, on which various terminals are arranged. The sealing portion **800** includes an edge portion (referred to as B in FIG. 2A) having four sides, and four corner portions (referred to as A in FIG. 2A).

Referring to FIG. 2B, the structure of the organic EL device in the display area **200** will now be described. A buffer layer **120** is formed on a substrate **110**, for example, a glass substrate using SiO₂. A semiconductor active layer **130** comprising an amorphous silicon or polycrystalline silicon is formed on one surface of the buffer layer **120**. Although not shown in detail, the semiconductor active layer **130** includes source

and drain regions that are doped with N+ type or P+ type impurities, and a channel region.

A gate electrode **150** is formed on an upper portion of the semiconductor active layer **130**, and an electric current is supplied to the channel region according to signals applied to the gate electrode **150**. In addition, when an electric current is supplied to the channel region, the source and drain regions communicate. The gate electrode **150** is formed of a material, such as MoW, or Al/Cu, considering adherence with a neighboring layer, surface flatness of the layer, and fabrication. In order to insulate the semiconductor active layer **130** from the gate electrode **150**, a gate insulating layer **140** of SiO₂ is formed between the semiconductor active layer **130** and the gate electrode **150** using a Plasma-Enhanced Chemical Vapor Deposition (PECVD) method.

An interlayer **160**, which can be a single layer or a double-layered structure, is formed of a material, such as SiO₂ or SiNx, arranged on an upper portion of the gate electrode **150**. A source/drain electrode **170** is arranged on an upper portion of the interlayer **160**. The source/drain electrode **170** is electrically connected to the source region and the drain region of the semiconductor active layer through a contact hole formed in the interlayer **160** and the gate insulating layer **140**.

A protection layer (a passivation layer and/or planarization layer) **180** is an insulating layer arranged on an upper portion of the source/drain electrode **170** to protect and flatten a Thin Film Transistor (TFT) on a lower portion thereof. The protection layer **180** can be formed of an inorganic material or an organic material, as a single layer structure, a doubled-layered structure consisting of an SiNx lower layer and an organic upper layer such as a benzocyclobutene or acryl upper layer, or a multilayered structure.

A first electrode **210** is arranged on a surface of the protection layer **180**, and one end of the first electrode **210** contacts the drain electrode **170** through a via hole **211** formed in the protection layer **180**. The first electrode **210** can be a transparent electrode, such as an Indium-Tin-oxide (ITO) electrode, when the organic EL display is a bottom emission display, and can be formed by depositing Al/Ca when the organic EL display is a front emission display.

An organic EL unit **230** can be formed as a small molecular or a high molecular organic film. If a small molecular organic film is used, a Hole Injection Layer (HIL), a Hole Transport Layer (HTL), an Emission Layer (EML), an Electron Transport Layer (ETL), and an Electron Injection Layer (EIL) can be stacked to form a single or multi-layered structure. An organic material such as copper phthalocyanine (CuPc), N,N-di(naphthalene-1-yl)-N,N'-diphenyl-benzidine (NPB), tris-8-hydroxyquinoline aluminum (Alq3) can be used. The small molecular organic layer is formed by a vapor deposition method.

The high molecular organic layer can include an HTL and an EML. A poly-3,4-Ethylenedioxythiophene (PEDOT) is used as the HTL, and a poly-phenylenevinylene (PPV) or polyfluorene-based high molecular organic material can be used as the EML. In addition, the high molecular organic layer is formed by a screen printing or an inkjet printing method.

A cathode electrode **400** is deposited on an upper portion of the organic EL unit **230**. However, the method of forming the cathode electrode **400** is not limited to the deposition method. An electrode power supply line **410** is arranged at an outer portion of the display area **200**, and a protection layer formed between an end of the cathode electrode **400** and the electrode power supply line **410** is an insulating layer. The end of the cathode electrode **400** and the electrode power supply line

410 can be electrically connected through a via hole **411** (refer to FIG. 2A) formed in the protection layer **400**.

Referring to FIG. 2A, a vertical circuit driving unit **500** is arranged between the electrode power supply line **410** and the display area **200**, and a horizontal circuit driving unit **600** is arranged on a lower side of the display area **200** in the drawing. However, the driving units **500** and **600** can be arranged in various alternative locations.

A driving power supply line **300** arranged on an outer edge of the display area **200** to supply driving power is connected to a driving line **310**, and the driving line **310** crosses the display area **200** and is electrically connected to the source electrode **170** (refer to FIG. 2B) arranged on a lower portion of the protection layer **180**.

The electrode power supply line **410**, the driving power supply line **300**, and the vertical/horizontal circuit driving units **500** and **600** transmit/receive electric signals to/from the outside through an electrode power terminal unit **420**, a driving power terminal unit **320**, and vertical/horizontal circuit terminal units **510** and **610**, respectively.

Referring to FIGS. 2A and 2B, a portion of the driving power supply line **300** is arranged between the sealing portion **800** and the substrate **100** along the sealing portion **700** to reduce a non-display area, that is, a dead space where various wires and driving units are arranged at the outer portion of the display area **200**. The outer edge of the driving power supply line **300** that overlaps the sealant **810** of the sealing portion **800** does not extend past the outer edge of the sealant **810**.

In FIG. 2B, the driving power supply line **300** is integrally formed when the source/drain electrodes **170** are formed on the display area **200**, using the same material. However, the driving power supply line **300** can alternatively be formed as a conductive layer (refer to **300c** of FIG. 4A) of the same material as the gate electrode **150**, or a conductive layer (refer to **300c** of FIG. 4B) can alternatively be formed of the same material as the semiconductor active layer **130**.

Also, two or more conductive layers can be arranged to compensate for a voltage drop in the conductive layer. That is, the driving power supply line **300** can include a first conductive layer formed of the same material as the source/drain electrodes **170**, and a second conductive layer **300b** formed of the same material as the gate electrode **150** (refer to FIG. 4B).

In addition, the driving power supply line **300** can include a first conductive layer **300a** formed of the same material as the source/drain electrodes **170**, and a third conductive layer **300c** formed of the same material as the semiconductor active layer **130** (refer to FIG. 4B), or can include all of the conductive layers (refer to FIG. 4C). That is, the driving power supply line **300** can include one or more conductive layers formed using the same material as the conductive layer formed on the display area **200**.

As shown in FIG. 2C, one or more penetration holes **301** are formed in a portion of the driving power supply line **300**, that is, a portion that overlaps the sealing portion **800** to strengthen the seal of the sealing portion **800**. For example, when the driving power supply line **300** is fabricated on the display area **200** using the same material as the source/drain electrodes **170**, that is, a metal such as MoW, the seal of the sealant **810** can be degraded due to a difference in thermal expansion coefficients between the upper and lower portions of the sealant **810**, that is, the glass and the metal layer, when the sealant **810**, which is formed of a synthetic material such as an epoxy resin, is cured by exposure to ultraviolet rays. In order to prevent the above problem, the penetration holes **301** can be formed in the driving power supply line **300** as shown in FIG. 2C.

FIG. 2C is a view of a configuration where the sealant **810** is located on an upper portion of the driving power supply line **300**. However, the sealant **810** can be applied in other ways. For example, a layer formed of the same material as the first electrode **210** (refer to FIG. 2B) of the display area **200** can be formed on the upper portion of the driving power supply line **300**, and the sealant **810** can be applied on that layer. Thus, a chemical reaction between the sealant **810** and the driving power supply line **300** can be prevented, and if the layer has a smaller width than the driving power supply line **300**, the contact area with the sealant **810** can be increased and the seal improved.

In FIG. 2C, the driving power supply line **300** is formed on the display area simultaneously with the formation of the source/drain electrodes **170** using the same material as the source/drain electrodes **170**. However, the driving power supply line **300** can be formed in other alternative ways. As shown in FIG. 4A, the driving power supply line **300** can include the first conductive layer **300a** formed of the same material as the source/drain electrode **170**, and the second conductive layer **300b** formed of the same material as the gate electrode **150**. In addition, the first conductive layer **300a** and the second conductive layer **300b** can have one or more first penetration holes **301a** and one or more second penetration holes **301b**, respectively. Also, as shown in FIG. 4B, the driving power supply line **300** can include the first conductive layer **300a** formed of the same material as the source/drain electrodes **170** on the display area **200**, and the third conductive layer **300c** formed of the same material as the semiconductor active layer **130**. In addition, the first conductive layer **300a** and the third conductive layer **300c** have one or more first penetration holes **301a** and one or more third penetration holes **301c**, respectively. Otherwise, as shown in FIG. 4C, the driving power supply line **300** can include all of the conductive layers **300a**, **300b**, and **300c**, or the second penetration hole **301b** and the third penetration hole **301c** can be additionally formed although not shown in the drawings. That is, the driving power supply line **300** can include one or more conductive layers, and the conductive layers can have one or more penetration holes on the portion that overlaps the sealing portion **800**. When two or more conductive layers are used as the driving power supply line **300**, the conductive layers are electrically connected to each other through a contact hole (not shown) to reduce voltage drops.

The penetration hole formed in the driving power supply line **300** according to the present invention can have additional features. That is, the penetration hole formed on the corner A in FIG. 2A can extend around the corner. FIG. 5A is an enlarged view of the corner A in FIG. 2A. As shown in FIG. 5A, the penetration hole **302** in the corner A can be extended as a slit around the corner A, unlike the other penetration holes in the edge portions, and the penetration holes **302** in that corner can be arranged in a plurality of rows. Also, it is desirable for the width of the penetration hole to be reduced when the penetration hole is close to the display area **200** to avoid problems caused when the penetration hole **302** is formed having a long slit shape around the corner.

Referring to FIG. 2D, one or more via holes **811** are arranged on a portion of the protection layer **180** that overlaps the sealing portion **800** to increase the contact area of the sealant **810** with layers stacked on the substrate, thereby tightly sealing the substrate **110** and the encapsulation substrate **900**. Also, at the bottom of the via hole **811** is an inorganic layer (interlayer **160** in FIG. 2D) under the protection layer **180**, which compensates for any weakness in the adhesion between the sealant **810** composed of a synthetic material, such as an epoxy resin, and the protection layer **180**

formed of the organic material, such as an acryl or BCB. In FIG. 2D, the driving power supply line is the layer **300b** formed of the same material as the gate electrode **150**. However, the present invention is not limited thereto.

The above embodiment that includes the via hole in the portion of the protection layer overlapping the sealing portion can further include the following feature. That is, the via hole formed in the corner (A in FIG. 2A) of the sealing portion **800** that overlaps the protection layer **180** arranged on the upper portion of the driving power supply line **300** can extend around the corner portion A. As shown in FIG. 5A, the via hole **811** in the corner A denoted by the dotted line can be formed as a long slit extending around the corner A, unlike the other via holes on the edge portion. In addition, the via holes at the corner A can be formed in a plurality of rows. It is desirable for the width of the via hole **811** to be reduced when the via hole **811** is close to the display area **200** to avoid problems caused when the via hole **811** is formed as a long slit due to the reduced circumference.

As shown in FIG. 2B, the penetration hole **301** and the via hole **811** can be formed simultaneously on the driving power supply line **300**. One or more penetration holes are formed on the conductive layer **300**, that is, the driving power supply line **300**, arranged between the inorganic layer (interlayer **160** in FIG. 2B) at the bottom of the via hole **811** and the protection layer **180**, and the positions of penetration hole **301** and the via hole **811** correspond to each other. When the sealant **810** comprises a synthetic material, such as an epoxy resin, contacts the source/drain electrode material or the gate electrode material, the synthetic material can react with the other materials, thereby damaging the conductive layer, that is, the driving power supply line **300**. Thus, it is desirable for the cross-section of the via hole **811** to be smaller than that of the corresponding penetration hole **301**.

In FIG. 2B, the bottom of the via hole **811** contacts the interlayer **160**. However, in FIGS. 3A and 3B, various modifications of the via hole **811** are shown. That is, as shown in FIG. 3A, when the layer formed of the same material as the source/drain electrodes **170** is used as the driving power supply line **300**, the via hole **811c** can be formed to penetrate the penetration hole **301** formed on the driving power supply line **300**, and the interlayer **160**, so that the bottom of the via hole **811** forms the gate insulation layer **140**. In addition, as shown in FIG. 3B, the via hole **811b** can penetrate the gate insulating layer **140** so that the bottom of the via hole **811b** meets the buffer layer **120**. Otherwise, as shown in FIG. 3C, the bottom of the via hole **811a** can contact the surface of the substrate **110**. When the depth of the via hole **811** is increased, the contact area with the sealing portion **810** increases and the adhesive strength between the substrate **110** and the encapsulation substrate **900** can be increased. However, if the substrate **110** is exposed, it can receive stress, and thus an appropriate depth of the via hole should be determined in consideration of design specifications. In the above embodiments, the via hole **811** penetrates the inorganic layer. However, alternative embodiments are possible. For example, the via hole **811** can be formed so as to not penetrate the interlayer **160** but only etch a part of the interlayer **160**. In addition, as shown in FIGS. 4A-4C, the driving power supply line **300** can include one or more conductive layers.

Also, the penetration hole **301** in the driving power supply line **300** and the via hole **811** in the protection layer **180** can be simultaneously formed in the corner (A in FIGS. 2A and 5A). As described above, it is desirable for the cross-section of the penetration hole **301** to be smaller than that of the

11

corresponding via hole **811**. This structure of the penetration hole **301** and the via hole **811** can be modified in various ways.

The penetration hole **301** formed in the driving power supply line **300** where it overlaps the edge portion (B in FIG. 2A) of the sealing portion, and the via hole **811** formed in the protection layer **180**, can be formed in various shapes. That is, the penetration hole **301** and the via hole **811** can have square shapes as shown in FIG. 2A or circular or rhombic shapes as shown in FIGS. 5B and 5C. The penetration holes and the via holes are arranged regularly with a constant interval between neighboring penetration holes/via holes, thereby enabling easy manufacturing of the pattern. Also, in order to prevent moisture from infiltrating into the penetration hole and/or the via hole, at least a part of a certain penetration hole and/or via hole transversely overlaps a part of a neighboring penetration hole and/or via hole toward the display area **200**. That is, as denoted by a hatched line in FIG. 5D, it is desirable for selected penetration holes and/or via holes to have overlapping portions with neighboring penetration holes/via holes. Thus, as shown in FIG. 5E, overlapping portions of large area between neighboring penetration holes and/or via holes can be formed in order to improve the function of preventing moisture from infiltrating the display device. When the penetration hole is formed in the driving power supply line, an appropriate type of penetration hole should be determined in consideration of problems in manufacturing, such as the voltage drop due to an increase in the penetration hole area, or due to a reduced distance between penetration holes.

The flat panel display device according to the present invention is not limited to above-described embodiments. Arrangements of lines such as the driving power supply line arranged at a peripheral portion of the display area, and layouts of elements such as the horizontal/vertical circuit driving units, can be modified in various ways. Also, while the above embodiments relate to an organic EL display, they can be applied to other types of flat panel displays, such as liquid crystal displays (LCDs).

According to the present invention, a part of the driving power supply line is located between the substrate and the sealant to increase the panel size.

In addition, one or more penetration holes are formed in the driving power supply line that crosses the sealing portion, thereby preventing or reducing damage to the sealing portion due to different thermal expansion rates when the sealing portion is cured.

In addition, in the flat panel display according to the present invention, one or more via holes are formed in the protection layer, which is preferably an organic protection layer, arranged on the driving power supply line, to make the sealing portion contact the inorganic layer under the organic protection layer through the via hole. This improves the seal and enhances protection against moisture infiltration.

Also, the driving power supply line includes one or more conductive layers to prevent the voltage from dropping.

The penetration hole and/or the via hole is formed to extend around the corner of the protection layer that overlaps with the driving power supply line and/or the sealant, thereby improving the seal at the corner.

The penetration hole and/or the via hole can be formed in various shapes in the edge portion of the protection layer where it overlaps with the driving power supply line and/or the sealant. Neighboring penetration holes and/or via holes can partially overlap with each other toward the display area, thereby further preventing moisture infiltration.

While the present invention has been particularly shown and described with reference to exemplary embodiments

12

thereof, it will be understood by those of ordinary skill in the art that various changes in form and details can be made therein without departing from the spirit and scope of the present invention as recited by the following claims.

What is claimed is:

1. A display comprising:

a display area displaying an image with display devices arranged on a substrate;

a sealing portion sealing the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer having at least a portion thereof arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line contacting the sealant;

wherein the at least one via hole extends so that a portion of the sealant closely contacts an upper surface of an inorganic layer under the protection layer; and

wherein the conductive layer is arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer.

2. The display of claim 1, wherein the protection layer comprises at least one organic layer.

3. The display of claim 1, wherein at least one penetration hole is arranged in the conductive layer.

4. The display of claim 3, wherein the conductive layer comprises a layer of the same material as that of source/drain electrodes on the display area.

5. The display of claim 1, wherein the inorganic layer at the bottom of the at least one via hole is of the same material as that of an interlayer on the display area.

6. The display of claim 1, wherein the inorganic layer at the bottom of the at least one via hole is of the same material as that of a gate insulating layer on the display area.

7. The display of claim 1, wherein the inorganic layer at the bottom of the at least one via hole is of the same material as that of a buffer layer on the display area.

8. The display of claim 1, wherein the bottom surface of the at least one via hole contacts a surface of the substrate.

9. The display of claim 1, wherein the display devices comprise organic electroluminescent devices.

10. A display comprising:

a display area displaying an image with display devices arranged on a substrate;

a sealing portion sealing the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer having at least a portion thereof arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line contacting the sealant;

wherein the at least one via hole extends so that a portion of the sealant closely contacts an inorganic layer under the protection layer; and

at least one penetration hole is arranged in the conductive layer;

wherein the at least one penetration hole communicates with the at least one via hole; and

13

wherein the conductive layer is arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer.

11. A display comprising:

a display area displaying an image with display devices arranged on a substrate;

a sealing portion sealing the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer having at least a portion thereof arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line contacting the sealant;

wherein the at least one via hole extends so that a portion of the sealant closely contacts an inorganic layer under the protection layer; and

at least one penetration hole is arranged in the conductive layer; and

wherein a cross-section of the at least one via hole is smaller than that of a communicating at least one penetration hole.

12. A display comprising:

a display area displaying an image with display devices arranged on a substrate;

a sealing portion sealing the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer having at least a portion thereof arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line contacting the sealant;

wherein the at least one via hole extends so that a portion of the sealant closely contacts an inorganic layer under the protection layer; and

at least one penetration hole is arranged in the conductive layer; and

wherein the conductive layer arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer comprises a layer of the same material as that of a gate electrode on the display area.

13. An organic electroluminescent display comprising:

a display area displaying an image with organic electroluminescent devices arranged on a substrate;

a sealing portion sealing at least the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer, at least a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line,

wherein the at least one via hole is extended so that a portion of the sealant directly contacts an upper surface of an inorganic layer under the protection layer; and

14

wherein the conductive layer is arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer.

14. An organic electroluminescent display comprising:

a display area displaying an image with organic electroluminescent devices arranged on a substrate;

a sealing portion sealing at least the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer, a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on an upper surface of the driving power supply line, and wherein the at least one via hole is extended so that a portion of the sealant directly contacts an upper surface of an inorganic layer under the protection layer;

wherein at least one penetration hole is arranged in the conductive layer arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer; and

wherein the conductive layer is arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer.

15. A display comprising:

a display area displaying an image with display devices arranged on a substrate;

a sealing portion sealing the display area with a sealant arranged along an outer edge portion of the display area; and

a driving power supply line supplying a driving voltage to the display area;

wherein the driving power supply line includes at least one conductive layer, a portion thereof being arranged between the sealing portion and the substrate and at least one via hole arranged in a protection layer arranged on top of the driving power supply line and extending so that a portion of the sealant directly contacts an upper surface of an inorganic layer under the protection layer through the at least one via hole;

wherein at least one via hole is arranged in the protection layer where it overlaps a corner of the sealing portion extending around a corner; and

wherein the conductive layer is arranged between the inorganic layer at the bottom of the at least one via hole and the protection layer.

16. The display of claim 15, wherein the protection layer comprises at least one organic layer.

17. The display of claim 15, wherein the inorganic layer at the bottom of the at least one via hole in the corner portion is of the same material as that of an interlayer on the display area.

18. The display of claim 15, wherein the inorganic layer at the bottom of the at least one via hole in the corner portion is of the same material as that of a gate insulating layer on the display area.

19. The display of claim 15, wherein the inorganic layer at the bottom of the at least one via hole in the corner portion is of the same material as that of a buffer layer on the display area.

20. The display of claim 15, wherein the bottom of the at least one via hole in the corner contacts a surface of the substrate.

21. The display of claim 15, wherein the display devices comprise organic electroluminescent devices.

15

22. A display comprising:
 a display area displaying an image with display devices
 arranged on a substrate;
 a sealing portion sealing the display area with a sealant
 arranged along an outer edge portion of the display area; 5
 and
 a driving power supply line supplying a driving voltage to
 the display area;
 wherein the driving power supply line includes at least one
 conductive layer, a portion thereof being arranged 10
 between the sealing portion and the substrate and at least
 one via hole arranged in a protection layer arranged on
 top of the driving power supply line and extending so
 that a portion of the sealant directly contacts an inor-
 ganic layer under the protection layer through the at least 15
 one via hole;
 wherein at least one via hole is arranged in the protection
 layer where it overlaps a corner of the sealing portion
 extending around a corner; and
 wherein at least one penetration hole is arranged around the 20
 corner portion of the at least one conductive layer, the at
 least one conductive layer being arranged between the
 inorganic layer at the bottom of the at least one via hole
 and the protection layer.

23. The display of claim 22, wherein the at least one pen- 25
 etration hole in the corner portion of the at least one conduc-
 tive layer communicates with the at least one via hole.

24. The display of claim 22, wherein a cross-section of the
 at least one via hole is smaller than that of a communicating 30
 at least one penetration hole.

25. A display comprising:
 a display area displaying an image with display devices
 arranged on a substrate;
 a sealing portion sealing the display area with a sealant
 arranged along an outer edge portion of the display area; 35
 and
 a driving power supply line supplying a driving voltage to
 the display area;
 wherein the driving power supply line includes at least one
 conductive layer, a portion thereof being arranged 40
 between the sealing portion and the substrate and at least
 one via hole arranged in a protection layer arranged on
 top of the driving power supply line and extending so
 that a portion of the sealant directly contacts an inor-
 ganic layer under the protection layer through the at least 45
 one via hole;
 wherein at least one via hole is arranged in the protection
 layer where it overlaps a corner of the sealing portion
 extending around a corner; and
 wherein the at least one conductive layer is arranged 50
 between the inorganic layer at the bottom of the at least
 one via hole and the protection layer and includes a layer
 of the same material as that of source/drain electrodes on
 the display area.

26. A display comprising: 55
 a display area displaying an image with display devices
 arranged on a substrate;
 a sealing portion sealing the display area with a sealant
 arranged along an outer edge portion of the display area; and
 a driving power supply line supplying a driving voltage to 60
 the display area;
 wherein the driving power supply line includes at least one
 conductive layer, a portion thereof being arranged

16

between the sealing portion and the substrate and at least
 one via hole arranged in a protection layer arranged on
 top of the driving power supply line and extending so
 that a portion of the sealant directly contacts an inor-
 ganic layer under the protection layer through the at least
 one via hole;
 wherein at least one via hole is arranged in the protection
 layer where it overlaps a corner of the sealing portion
 extending around a corner; and
 wherein the at least one conductive layer is arranged
 between the inorganic layer at the bottom of the at least
 one via hole and the protection layer and includes a layer
 of the same material as that of a gate electrode on the
 display area.

27. A display comprising:
 a display area displaying an image with display devices
 arranged on a substrate;
 a sealing portion sealing the display area with a sealing
 material arranged along an outer edge portion of the
 display area; and
 a driving power supply line supplying a driving voltage to
 the display area;
 wherein the driving power supply line includes at least one
 conductive layer, a portion thereof being arranged
 between the sealing portion and the substrate and at least
 one via hole arranged in a protection layer arranged on a
 top of the driving power supply line and extending so
 that at least a portion of the sealing material directly
 contacts an upper surface of an inorganic layer under the
 protection layer through the at least one via hole;
 wherein at least one via hole is arranged in the protection
 layer where it overlaps the sealing portion transversely
 with a portion of a neighboring via hole arranged toward
 the display area; and
 wherein the conductive layer is arranged between the inor-
 ganic layer at the bottom of the at least one via hole and
 the protection layer.

28. A display comprising:
 a display area displaying an image with display devices
 arranged on a substrate;
 a sealing portion sealing the display area with a sealing
 material arranged along an outer edge portion of the
 display area; and
 a driving power supply line supplying a driving voltage to
 the display area;
 wherein the driving power supply line includes at least one
 conductive layer, a portion thereof being arranged
 between the sealing portion and the substrate and at least
 one via hole arranged in a protection layer arranged on a
 top of the driving power supply line and extending so
 that at least a portion of the sealing material directly
 contacts an inorganic layer under the protection layer
 through the at least one via hole;
 wherein at least one via hole is arranged in the protection
 layer where it overlaps the sealing portion transversely
 with a portion of a neighboring via hole arranged toward
 the display area; and
 wherein at least one penetration hole is arranged to com-
 municate with the at least one via hole in a conductive
 layer, the conductive layer being arranged between the
 inorganic layer at the bottom of the at least one via hole,
 and the protection layer.

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